




Product Specification

AU OPTRONICS CORPORATION

() Preliminary Specifications

(V) Final Specifications

Module	14.0" FHD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B140HTT01.0 (HW:0A)
Note ()	<i>e-TP Display</i> (LCM : B140HTN01.3 + TP : I140FGT03.0)

Customer

Date

Checked &
Approved by

Date

Note: This Specification is subject to change without notice.

Approved by

Date

Jonken Fan

03/14/2014

Prepared by

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03/14/2014

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Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.0 2013/09/05	All	First Edition for Customer		
0.1 2013/10/08	5	2.1 General Specification	Update Weight	Update
	29	9. Shipping and Package	9.1 Shipping Label Format update 9.2 Carton Label Format update	Update
0.2 2013/10/14	29-30	8. Mechanical Characteristics	Add Drawing	Add
0.3 2013/10/15	32-34	10. Appendix: EDID Description	Update EDID	Update
0.4 2013/11/12	7	2.2 General Touch Specification	Add Touch panel sensor IC and TP Power Consumption	Add
	13	4.2 Absolute Ratings of Touch Sensor	Add Touch Sensor Power Voltage	Add
	18	5.2.1 LED characteristics	Add LED Life-Time	Add
	19	5.3 Touch Sensor Power Consumption	Add Touch panel power supply	Add
	24	6.4 Interface Timing 6.4.1 Timing Characteristics	Add information	Add
	29-30	8. Mechanical Characteristics	Drawing update	Update
	31	9. Shipping and Package 9.1 Shipping Label Format 9.2 Carton Label Format	Label update	Update
0.5 2013/12/09	5	2.1 General Specification	Power Consumption update	Update
	7	2.2 General Touch Specification	Add TP F/W version & TP Power Consumption	Add & Update
	8	2.3 Optical Characteristics	Add Color / Chromaticity Coordinates	Add
	15-17	5.1.1 Power Specification	Add power & Voltage data	Add
	18	5.2.1 LED characteristics 5.2.2 Backlight input signal characteristics	Add LED characteristics & Backlight input signal	Add
	32-34	10. Appendix: EDID Description	Update EDID	Update
0.6 2014/02/24	7	2.2 General Touch Specification	Update TP F/W version	Update
2014/02/26	6	2.1 General Specification	Update support color	Update
1.0 2014/03/13	6	2.1 General Specification	Update Power Consumption	Update
	8	2.3 Optical Characteristics	Update Color / Chromaticity Coordinates	Update
1.1 2014/03/14	7	2.2 General Touch Specification	Update TP F/W version	Update

1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 10) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentarily. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 11) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 12) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.

2. General Description

B140HTT01.0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 FHD, 1920(H) x1080(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are eDP (Embedded DisplayPort) interface compatible.

B140HTT01.0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 °C condition:

Items	Unit	Specifications			
Screen Diagonal	[mm]	354.69			
Active Area	[mm]	309.14x173.89			
Pixels H x V		1920x3(RGB) x 1080			
Pixel Pitch	[mm]	0.161X0.161			
Pixel Format		R.G.B. Island			
Display Mode		Normally White			
White Luminance (ILED=23mA) (Note: ILED is LED current)	[cd/m ²]	270 typ. (5 points average) 229 min. (5 points average)			
Luminance Uniformity		1.25 max. (5 points)			
Contrast Ratio		500 typ			
Response Time	[ms]	8 typ / 16 Max			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.			
Power Consumption	[Watt]	4.8 W max (Include touch panel)			
Weight	[Grams]	295 g max (Panel Only)g 395 g max (Total Solution) ¹			
Physical Size	[mm]		Min.	Typ.	Max.
		Length	325.93	326.18	326.43
		Width	204.60	205.10	205.60

¹ Total solution max weight includes touch sensor FPCA and OGS.



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		Thickness	-	-	3.0 (Panel Side) 3.0 (PCBA Side)
Total solution [Note: OGS Touch module]	[mm]		Min.	Typ.	Max.
		Length	325.93	326.18	326.43
		Width	204.60	205.10	205.60 (206.94 with FPCA)
		Thickness	-	-	3.98 (Panel Side) 3.8 (PCBA Side) 5.0 (Total)
Electrical Interface		2 Lane eDP 1.2			
Glass Thickness	[mm]	0.4			
Surface Treatment		Glare, Hardness 3H			
Support Color		262K colors (RGB 6-bit) (6-bit+ RFC, System input 8 bit to PCB of LCM is necessary)			
Temperature Range	[°C] [°C]	-20 to +60			
Operating					
Storage (Non-Operating)		-20 to +60			
RoHS Compliance		RoHS Compliance			



2.2 General Touch Specification

Item	Spec	Unit
Type of Touch Sensor	Projective Capacitive (OGS)	
Panel Size	14.0'	
Outline Dimension	321.10 X 185.9 typ	mm
Total Thickness	0.7 typ	mm
Total Weight	120 max	g
TP View Area	310.40 X 174.95 typ	mm
TP Active Area	311.40 X 175.95 typ	mm
Interface	I2C	
Report Rate	Follow win8 – 100Hz	Hz
Multi-Touch Point	10 points	
Input method	Finger	
Touch panel sensor IC	ELAN 3958	
Channel	72 x 41	
Distance between 2 point	Follow win8 – 12	mm
Surface hardness	7	H
TP F/W version	11.20 only for I2C	
BM ink	PANTONE BLACK C	
	Active Mode: 162	mW
TP Power Consumption	Idle Mode: 108	mW
	Sleep Mode: 1	mW



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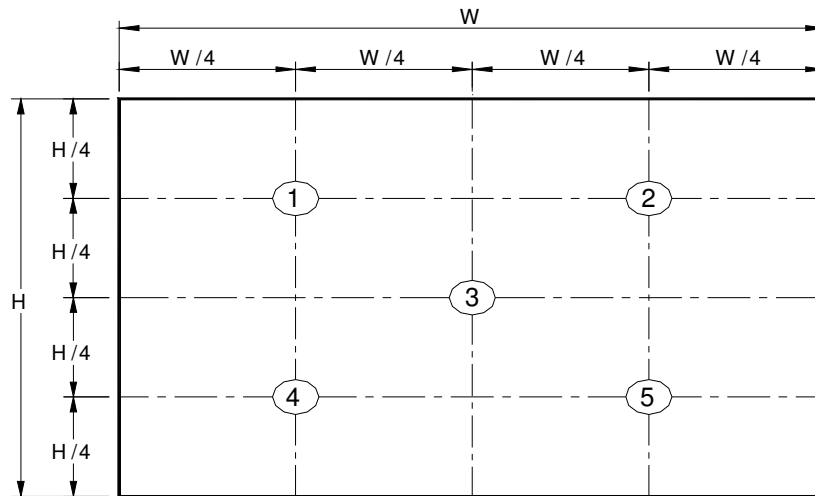
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2.3 Optical Characteristics

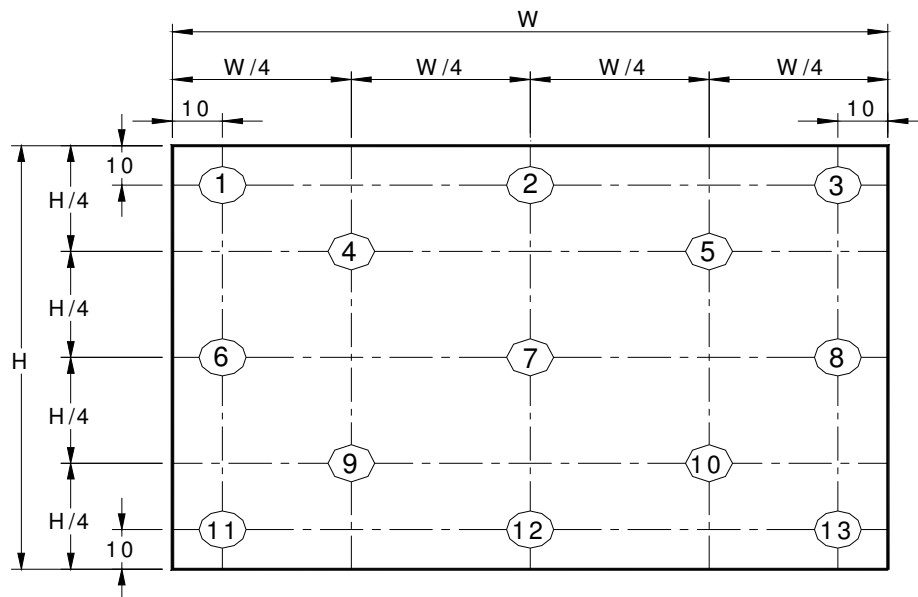
The optical characteristics are measured under stable conditions at 25°C (Room Temperature) :

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
White Luminance ILED=23mA (Base Panel Only)		5 points average	229	270	-	cd/m2	1, 4, 5.
Viewing Angle	θR θL	Horizontal (Right) CR = 10 (Left)	40 40	45 45	- -	degree	4, 9
	ψH ψL	Vertical (Upper) CR = 10 (Lower)	10 30	15 35	- -		
Luminance Uniformity	δ5P	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity	δ13P	13 Points	-	-	1.6		2, 3, 4
Contrast Ratio	CR		400	500	-		4, 6
Cross talk	%				4		4, 7
Response Time	TRT	Rising + Falling	-	8	16		
Color / Chromaticity Coordinates	Red	Rx	0.590	0.620	0.650	-	4
		Ry	0.320	0.350	0.380		
	Green	Gx	0.290	0.320	0.350		
		Gy	0.570	0.600	0.630		
	Blue	Bx	0.120	0.150	0.180		
		By	0.090	0.120	0.150		
	White	Wx	0.283	0.313	0.343		
		Wy	0.299	0.329	0.359		
NTSC	%		-	60	-		

Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

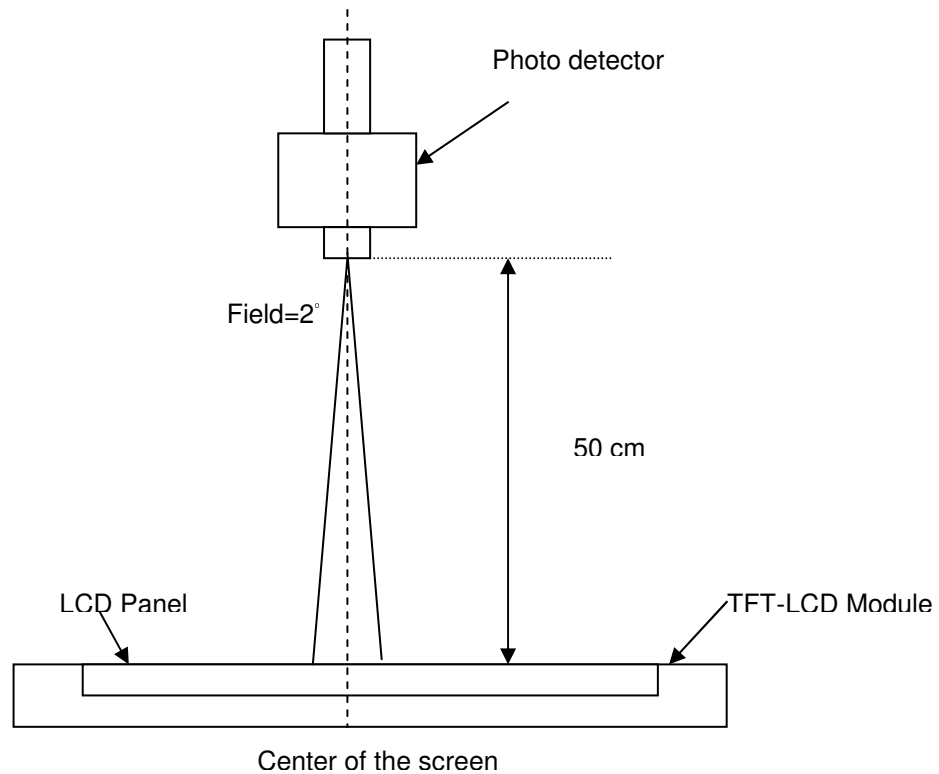
$$\delta_{W5} = \frac{\text{Maximum Brightness of five points}}{\text{Minimum Brightness of five points}}$$

$$\delta_{W13} = \frac{\text{Maximum Brightness of thirteen points}}{\text{Minimum Brightness of thirteen points}}$$

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting

Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5 : Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points , $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$

$L(x)$ is corresponding to the luminance of the point X at Figure in Note (1).

Note 6 : Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio (CR)} = \frac{\text{Brightness on the "White" state}}{\text{Brightness on the "Black" state}}$$

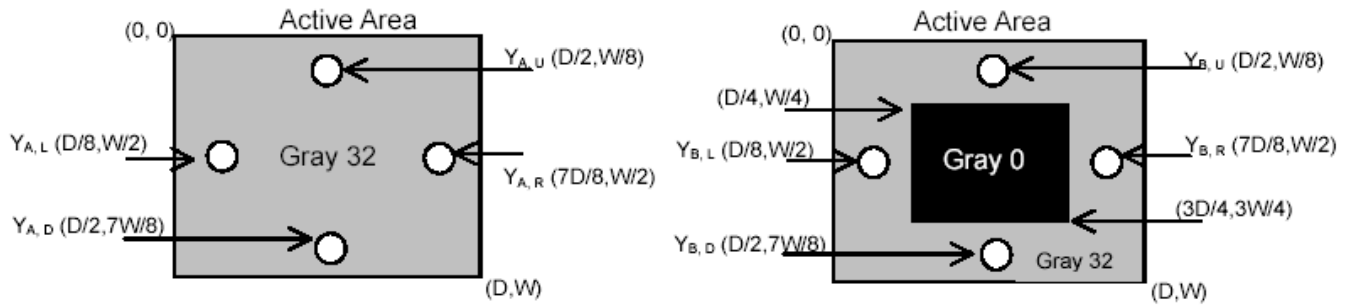
Note 7 : Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

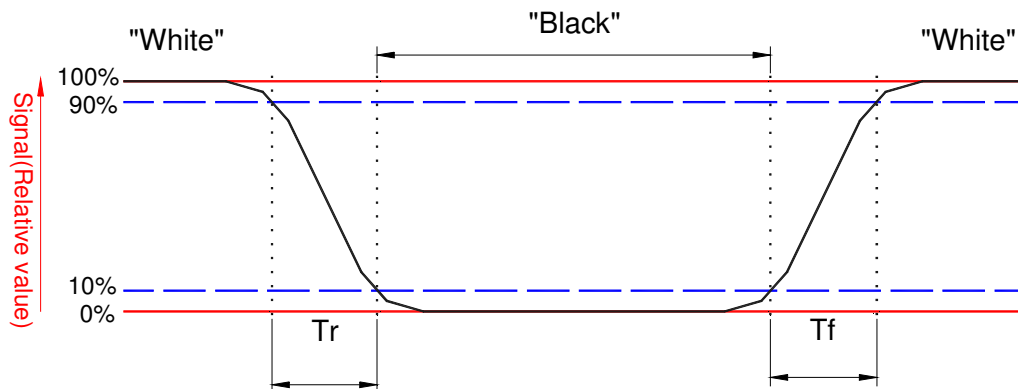
Y_A = Luminance of measured location without gray level 0 pattern (cd/m²)

Y_B = Luminance of measured location with gray level 0 pattern (cd/m²)



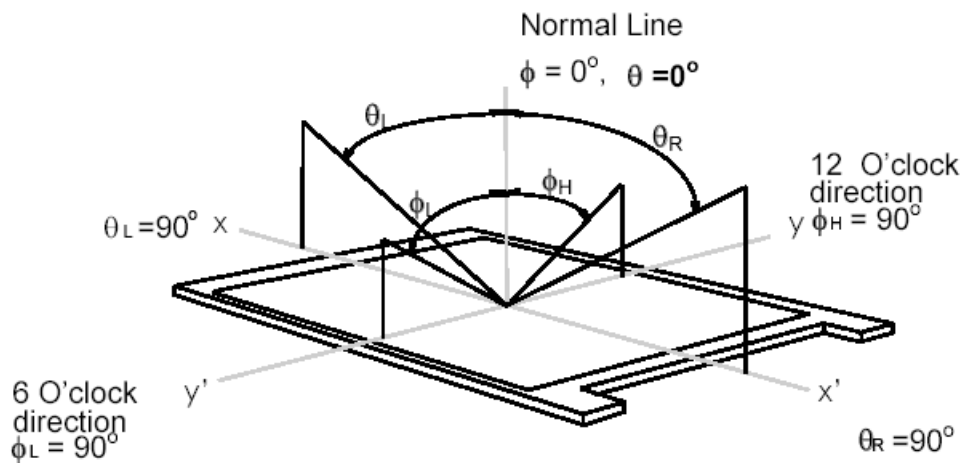
Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

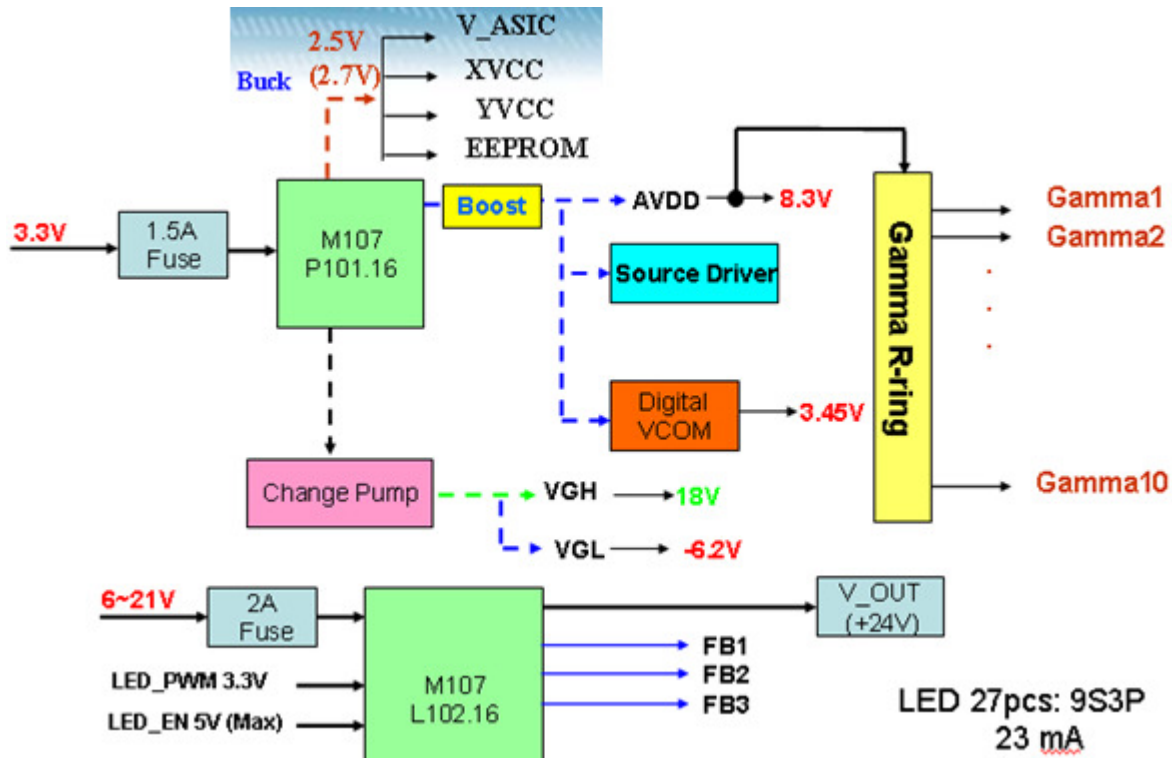


Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio ≥ 10 , at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



3. Functional Block Diagram



4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Touch Sensor

Item	Symbol	Min	Max	Unit	Conditions
Touch Sensor Power Voltage	Vin	3.15	3.6	[Volt]	

4.3 Absolute Ratings of Environment

Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)



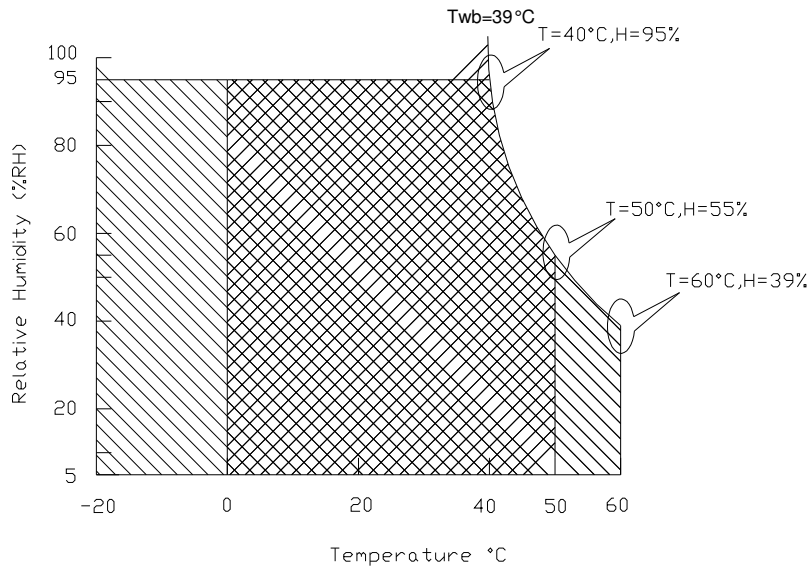
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Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

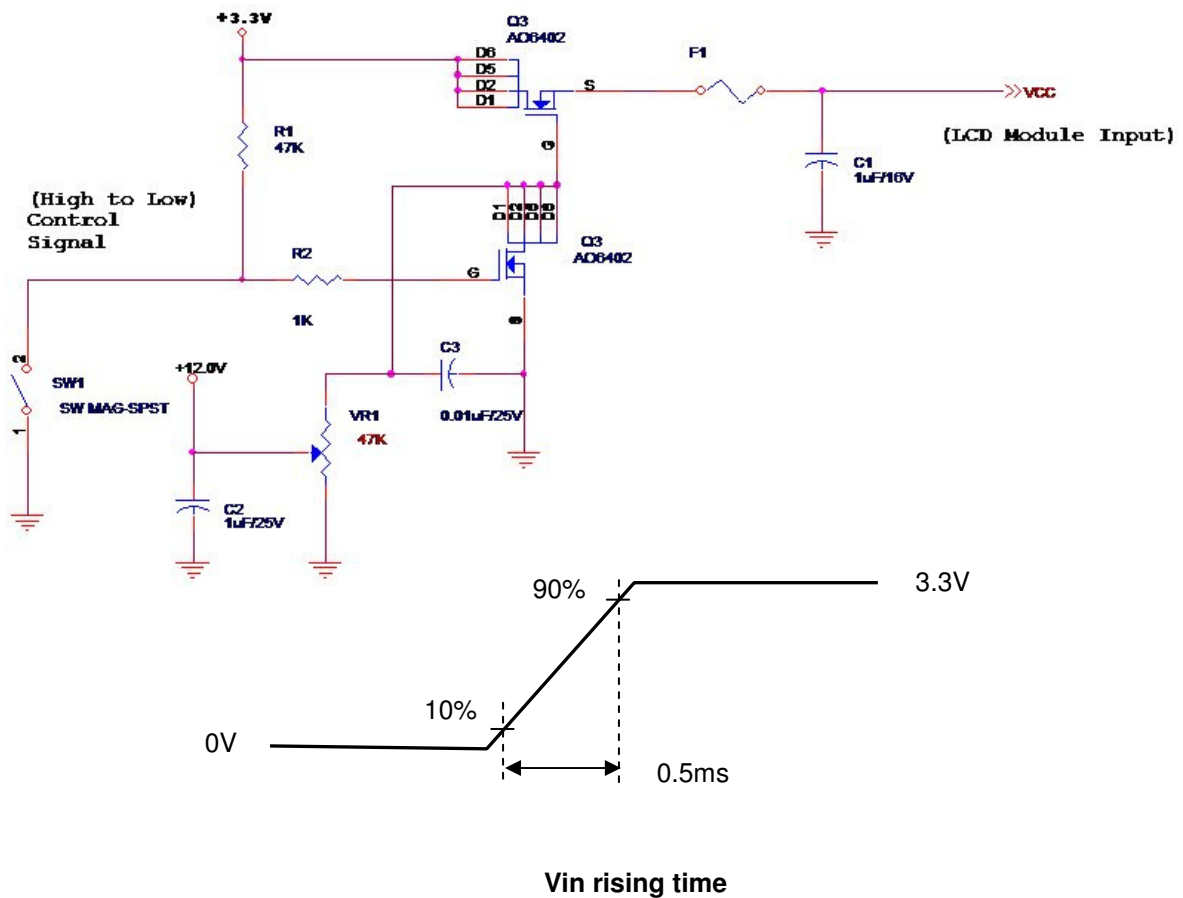
Input power specifications are as follows;

The power specification are measured under 25°C and frame frequency under 60Hz

Symble	Parameter	Min	Typ	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	1	[Watt]	Note 1
IDD	IDD Current	-	-	303	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : White Pattern at 3.3V driving voltage. ($P_{max}=V_{3.3} \times I_{white}$)

Note 2 : Measure Condition



5.1.2 Signal Electrical Characteristics

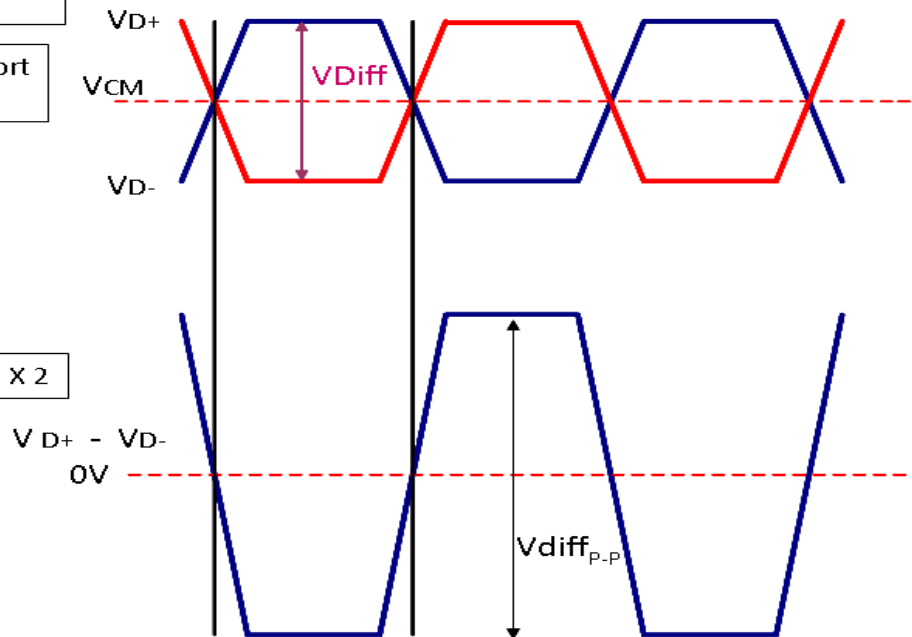
Signal electrical characteristics are as follows;

Display Port main link signal:

Differential pair VD+ , VD-
Which is one Display port
Main link

VCM of Display port
Main link

$$V_{diffP-P} = [(VD+) - (VD-)] \times 2$$

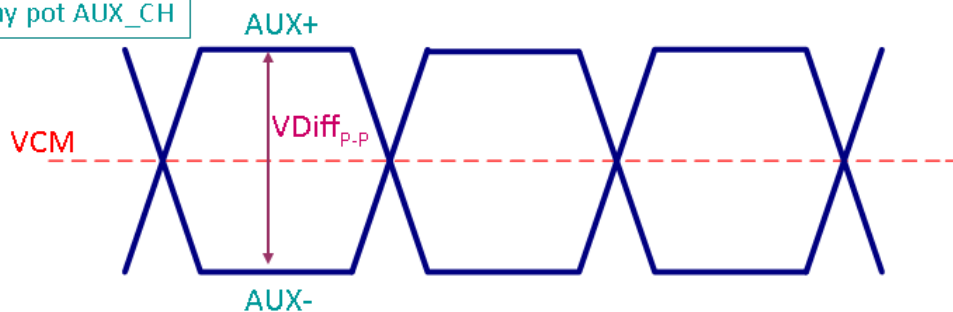


Display port main link					
		Min	Typ	Max	unit
VCM	RX input DC Common Mode Voltage	0	---	2	V
VDiff _{P-P}	Peak-to-peak Voltage at a receiving Device	120	---	---	mV

Follow as VESA display port standard V1.1a

Display Port AUX_CH signal:

Differential AUX+ , AUX-
Which is Display port AUX_CH





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Display port AUX_CH					
		Min	Typ	Max	unit
VCM	AUX DC Common Mode Voltage	0	---	2	V
VDiff _{P-P}	AUX Peak-to-peak Voltage at a receiving Device	0.32	---	1.36	V

Follow as VESA display port standard V1.1a.

Display Port VHPD signal:

Display port VHPD					
		Min	Typ	Max	unit
VHPD	HPD Voltage	--	--	3.6	V

Follow as VESA display port standard V1.1a.



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5.2 Backlight Unit

5.2.1 LED characteristics

Parameter	Symbol	Min	Typ	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	3.6	[Watt]	(Ta=25°C), Note 1
LED Life-Time	N/A	15000	-	-	Hour	(Ta=25°C), Note 2 I _F =20 mA

Note 1: Calculator value for reference $P_{LED} = V_F$ (Normal Distribution) * I_F (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Typ	Max	Units	Remark
LED Power Supply	VLED (Note 1)	7.0	12.0	21.0	[Volt]	Define as Connector Interface (Ta=25°C)
LED Enable Input High Level	VLED_EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level		-	-	0.5	[Volt]	
PWM Logic Input High Level	VPWM_EN	2.5	-	5.5	[Volt]	
PWM Logic Input Low Level		-	-	0.5	[Volt]	
PWM Input Frequency	FPWM	200	1K	2K	Hz	
PWM Duty Ratio	Duty	5	-	100	%	

Note 1 : Recommend system pull up/down resistor no bigger than 10kohm



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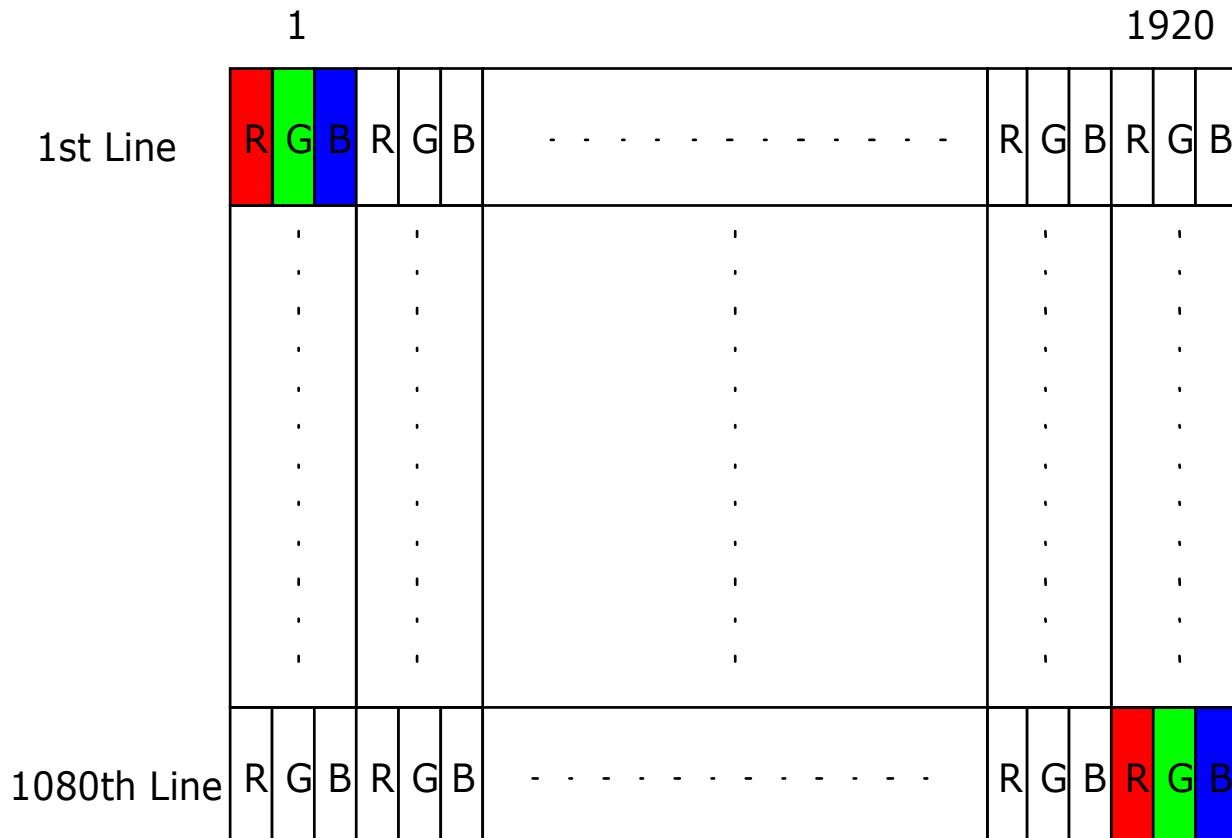
5.3 Touch Sensor Power Consumption

Items	Symbol	Specifications			Unit	Notes
		Min.	Typ.	Max.		
Touch Panel Power Supply	VDD	-	-	3.6	V	

6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.



6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	I-PEX JP CO.,LTD; 20455-040E-12
Mating Housing/Part Number	IPEX or compatible

6.3.2 Pin Assignment (with Touch Sensor Pin Assignment)

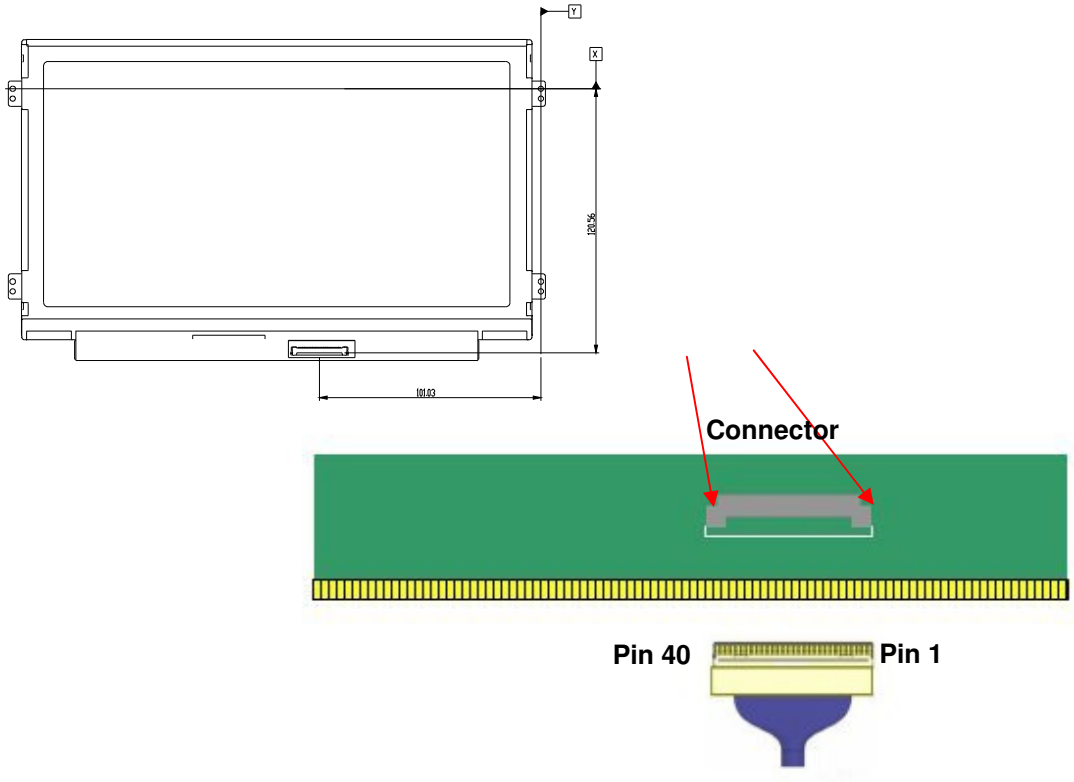
PIN NO	Symbol	Function
1	NC	No Connect (Reserved for DCR)
2	H_GND	High Speed Ground
3	Lane1_N	Comp Signal Link Lane 1
4	Lane1_P	True Signal Link Lane 1
5	H_GND	High Speed Ground
6	Lane0_N	Comp Signal Link Lane 0
7	Lane0_P	True Signal Link Lane 0
8	H_GND	High Speed Ground
9	AUX_CH_P	True Signal Auxiliary Ch.
10	AUX_CH_N	Comp Signal Auxiliary Ch.
11	H_GND	High Speed Ground
12	LCD_VCC	LCD logic and driver power
13	LCD_VCC	LCD logic and driver power
14	LCD_Self_Test or NC	LCD Panel Self Test Enable (Optional)
15	LCD_GND	LCD logic and driver ground
16	LCD_GND	LCD logic and driver ground
17	HPD	HPD signal pin
18	BL_GND	Backlight ground
19	BL_GND	Backlight ground
20	BL_GND	Backlight ground



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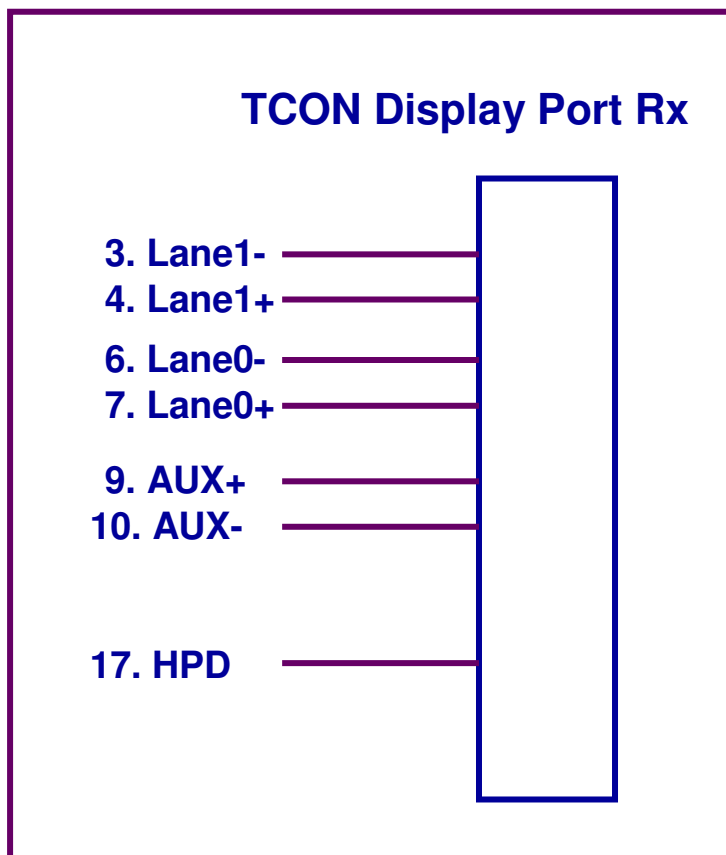
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21	BL_GND	Backlight ground
22	BL_Enable	Backlight On / Off
23	BL_PWM_DIM	System PWM signal Input
24	NC	No connect (Reverse for AUO TEST only)
25	NC	No connect (Reverse for AUO TEST only)
26	BL_PWR	Backlight power (6V~21V)
27	BL_PWR	Backlight power (6V~21V)
28	BL_PWR	Backlight power (6V~21V)
29	BL_PWR	Backlight power (6V~21V)
30	NC	No Connect (Reserved for CM)
31	TP_D-	USB Data- for Touch
32	TP_D+	USB Data+ for Touch
33	GND	Ground-Shield
34	VTSP	Touch panel power supply (3.3V)
35	VTSP	Touch panel power supply (3.3V)
36	NC/TP_EN	No Connection (Reserve for Touch function enable)
37	TP_CLK	I2C Clock for Touch (NC for USB input)
38	TP_Data	I2C Data for Touch (NC for USB input)
39	INT	Interrupt for Touch (NC for USB input)
40	RST	Reset for Touch (NC for USB input)



Note1: Start from right side.

Note2: Input signals shall be low or High-impedance state when VDD is off.
Internal circuit of **eDP inputs** are as following.



6.4 Interface Timing

6.4.1 Timing Characteristics

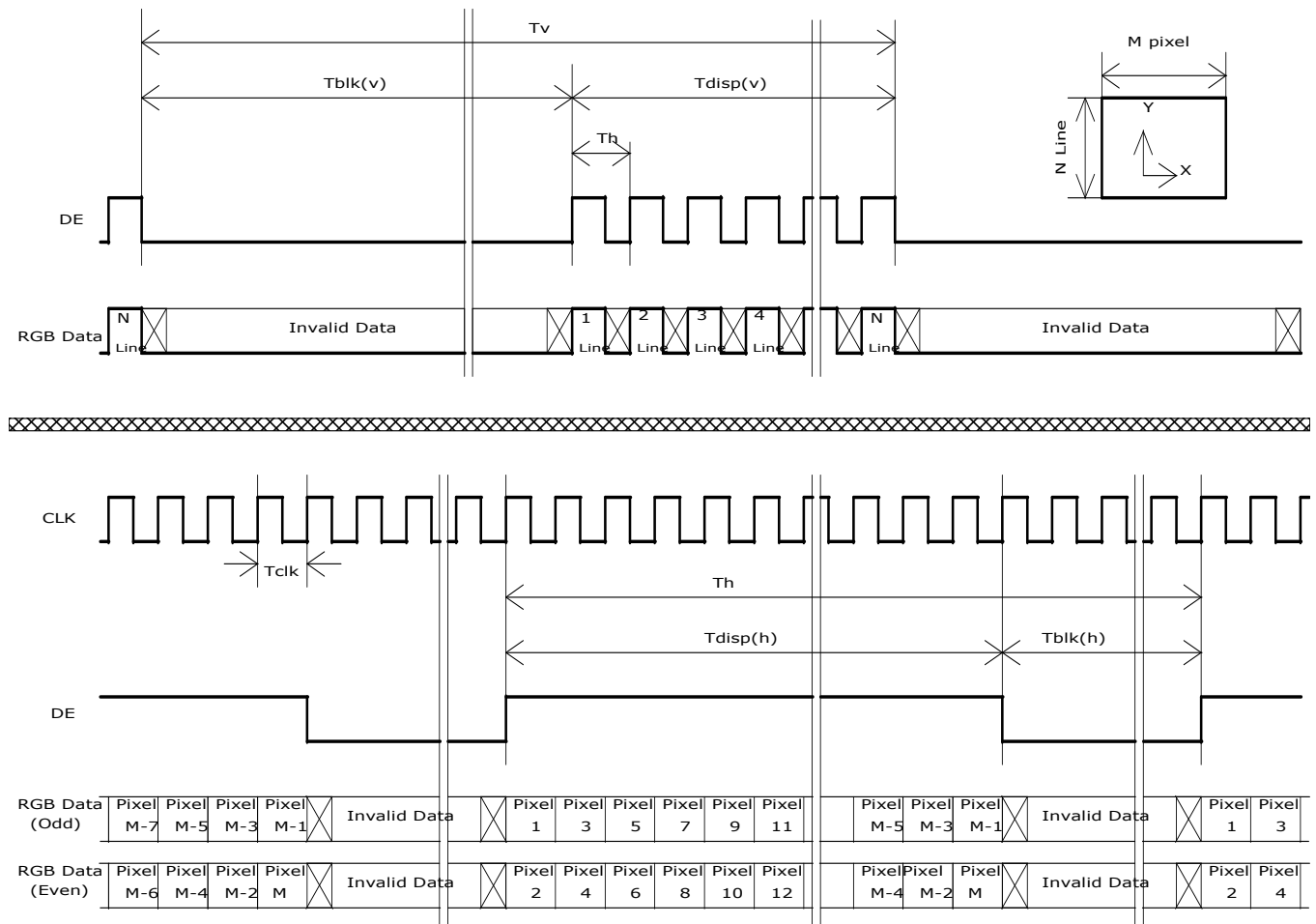
Basically, interface timings should match the 1920x1080 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Typ.	Max.	Unit
Frame Rate		-		60	-	Hz
Clock frequency		1/ T _{Clock}	69.4	70.5	75	MHz
Vertical Section	Period	T _V	1112	1120	1152	T _{Line}
	Active	T _{VD}	1080			
	Blanking	T _{VB}	32	38	72	
Horizontal Section	Period	T _H	1040	1050	1084	T _{Clock}
	Active	T _{HD}	960			
	Blanking	T _{HB}	80	90	124	

Note : 1. DE mode only

2. The maximum clock frequency = $(1920+B) \times (1080+A) \times 60 < 80\text{MHz}$

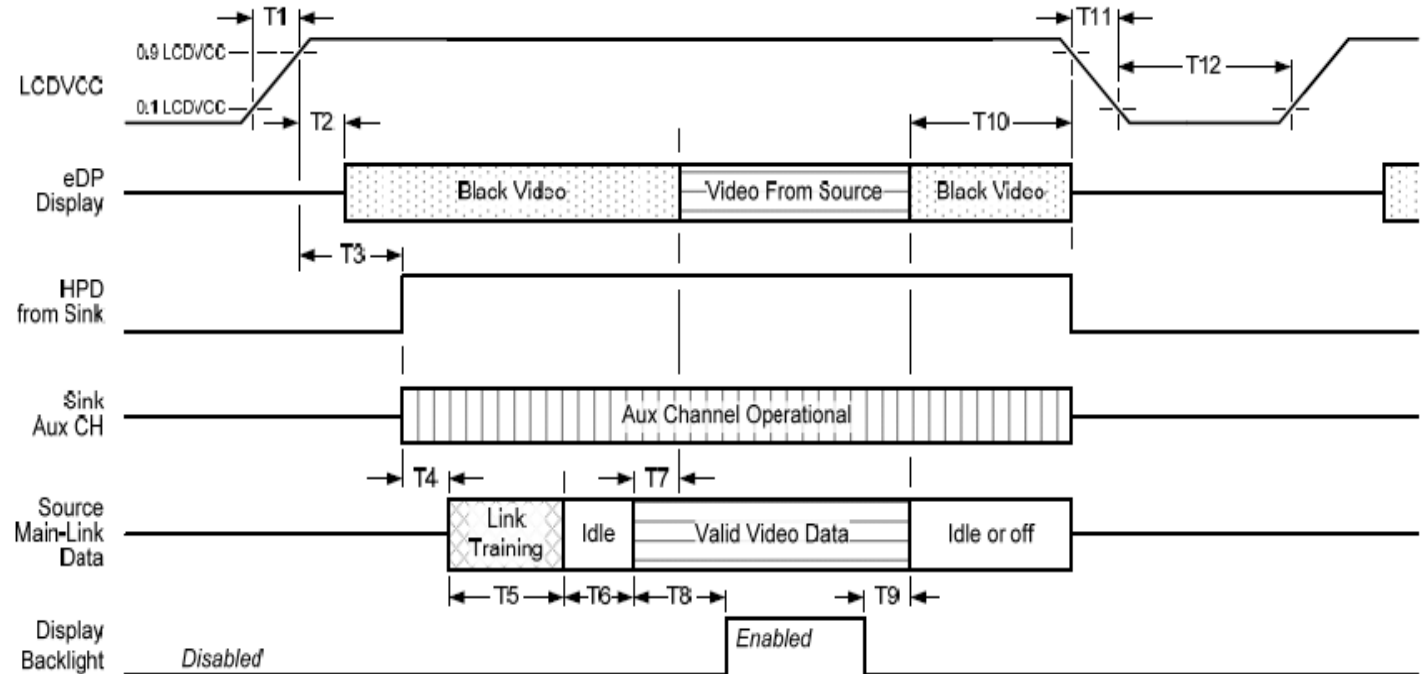
6.4.2 Timing diagram



6.4 Power ON/OFF Sequence

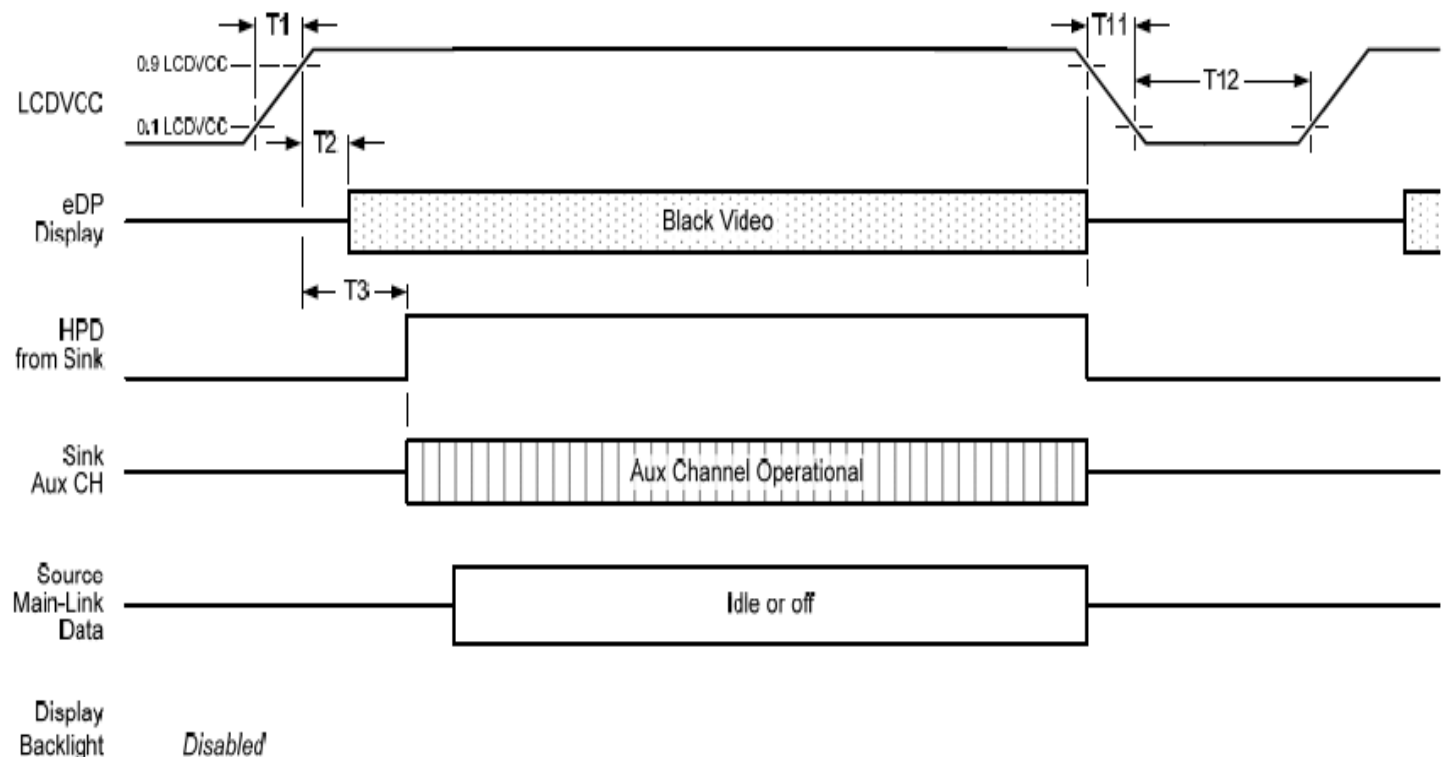
Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off

Display Port panel power sequence:



Display port interface power up/down sequence, normal system operation

Display Port AUX_CH transaction only:



Display port interface power up/down sequence, AUX_CH transaction only



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Display Port panel power sequence timing parameter:

Timing parameter	Description	Reqd. by	Limits			Notes
			Min.	Typ.	Max.	
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms	
T2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source
T3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.
T4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.
T5	link training duration	source				dependant on source link to read training protocol.
T6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.
T7	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.
T8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.
T9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.
T10	delay from end of valid video data from source to power off	source	0ms		500ms	
T11	power rail fall time, 90% to 10%	source			10ms	
T12	power off time	source	500ms			

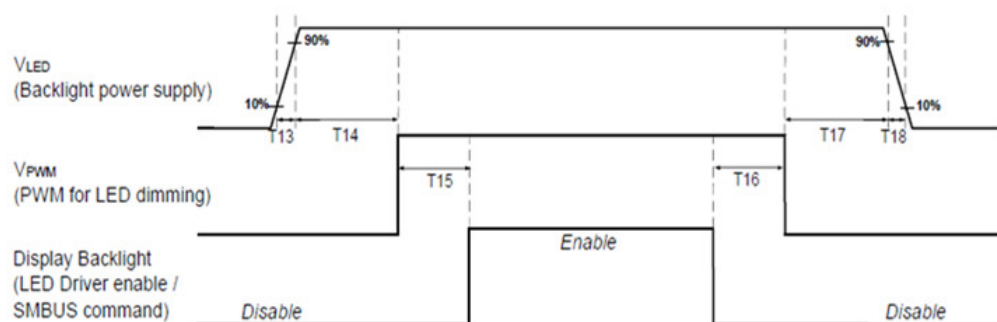
Note1: The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:

- upon LCDVDD power on (within T2 max)-when the "Novideostream_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).
- when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

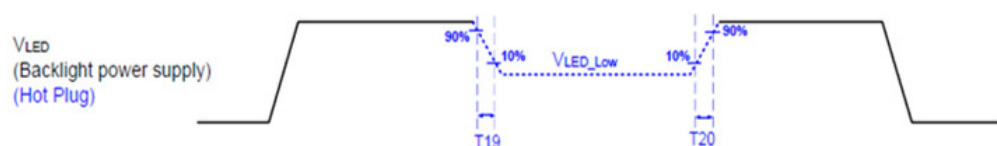
Note 2: The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

Note 3: The sink must support AUX_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX_CH transaction with the time specified within T3 max.

Display Port panel B/L power sequence timing parameter:



Note : When the adapter is hot plugged, the backlight power supply sequence is shown as below.



	Min (ms)	Max (ms)
T13	0.5	10
T14	10	-
T15	10	-
T16	10	-
T17	10	-
T18	0.5	10
T19	1*	-
T20	1*	-

Seamless change: $T19/T20 = 5 \times T_{PWM}^*$

* $T_{PWM} = 1/PWM \text{ Frequency}$

7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 1.5 Grms
- Frequency: 10 - 500Hz Random
- Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

- Test method: Non-Operation
- Acceleration: 220 G , Half sine wave
- Active time: 2 ms
- Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40°C, 90%RH, 240h	
High Temperature Operation	Ta= 60°C, Dry, 240h	
Low Temperature Operation	Ta=0°C, 240h	
High Temperature Storage	Ta= 60°C, 240h	
Low Temperature Storage	Ta= -20°C, 240h	
Thermal Shock Test	Ta=-20°C(30min) ~60°C(30min), 20cycles condition.	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

Note1: According to EN 61000-4-2 , ESD class B: Some performance degradation allowed. No data lost
 . Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 9

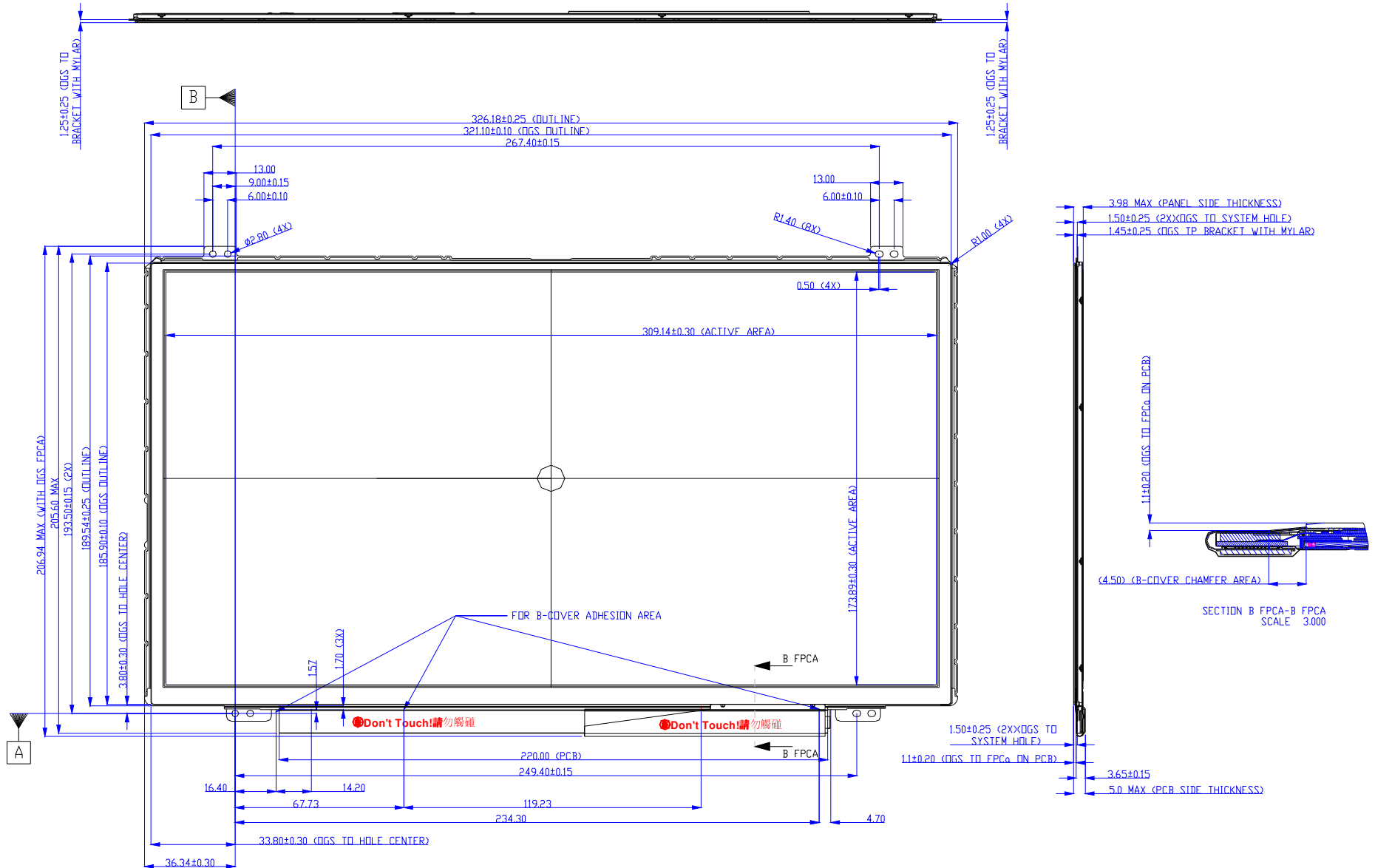


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8. Mechanical Characteristics

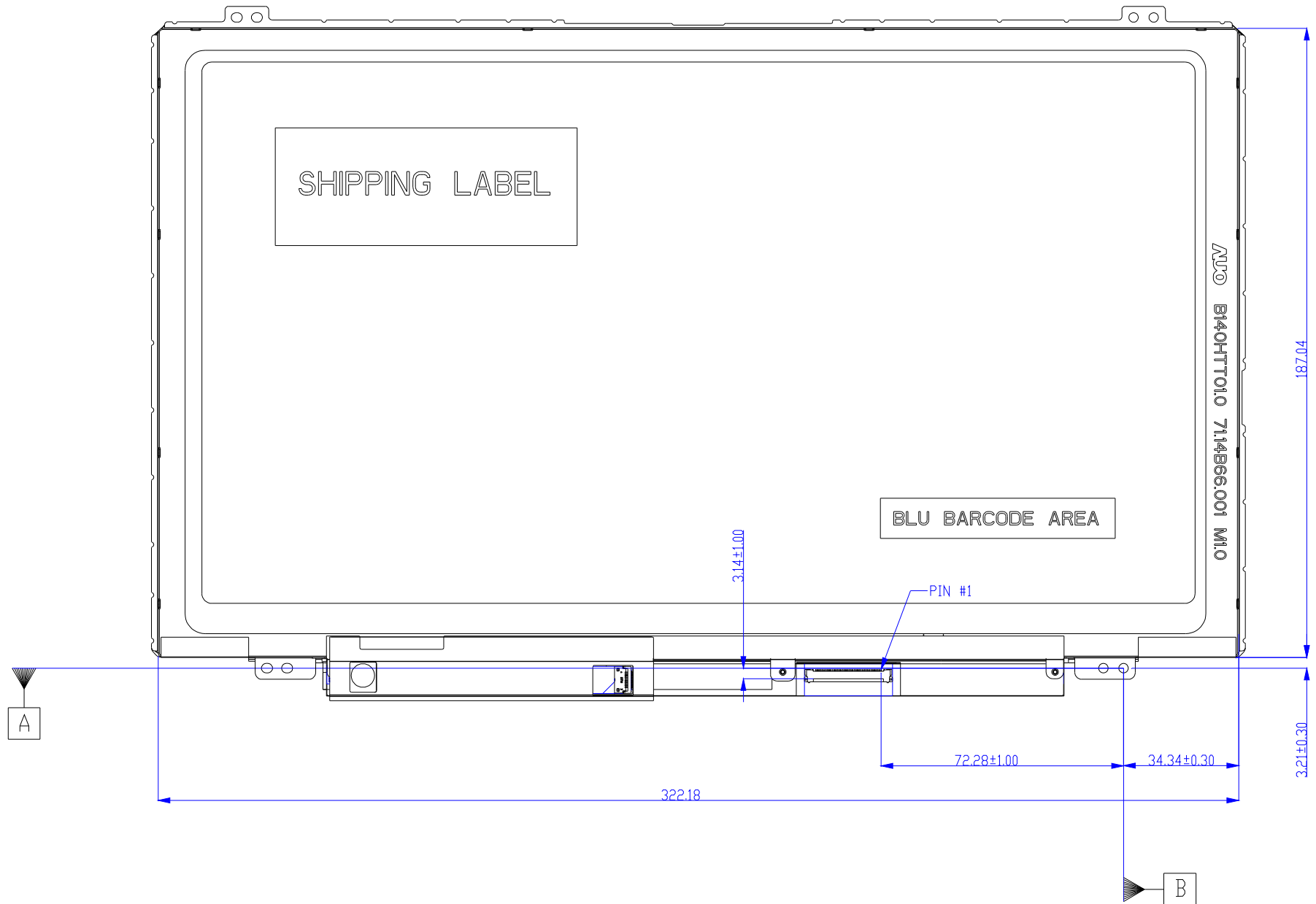
8.1 Total Solution Outline Dimension






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9. Shipping and Package

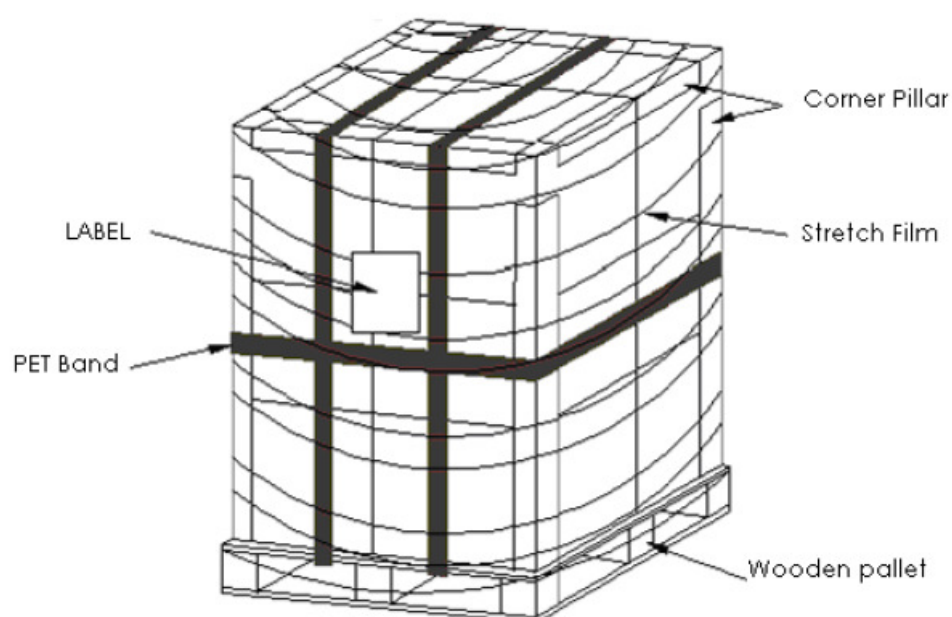
9.1 Shipping Label Format

 *XXXXXXXXXXXX-XXXXXX	Manufactured XX/XX Model No: B140HTT01.0 AU Optronics Made in China (S01) H/W: 0A F/W:1	
 CT:CEBNH01XXXXXX		

9.2 Carton Label Format

AU Optronics	QTY	42	RoHS	Pb
MODEL NO :	B140HTT01.0			
PART NO :	97.14B66.020			
CUSTOMER NO :	751329-392			
CARTON NO :				
Made in China	*ZS0100-0652300205*			

9.3 Shipping Package of Palletizing Sequence





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10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	3D	00111101	61	
0B	hex, LSB first	10	00010000	16	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	17	00010111	23	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	95	10010101	149	
15	Max H image size (rounded to cm)	1F	00011111	31	
16	Max V image size (rounded to cm)	11	00010001	17	
17	Display Gamma $(=(\text{gamma} \times 100) - 100)$	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	9F	10011111	159	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	E5	11100101	229	
1B	Red x (Upper 8 bits)	96	10010110	150	
1C	Red y/ highER 8 bits	58	01011000	88	
1D	Green x	53	01010011	83	
1E	Green y	8A	10001010	138	
1F	Blue x	26	00100110	38	
20	Blue y	24	00100100	36	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	00000001	1	
28	Standard timing #2	01	00000001	1	
29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	



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2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	14	00010100	20	
37	Pixel Clock/10000 USB	37	00110111	55	
38	Horz active Lower 8bits	80	10000000	128	
39	Horz blanking Lower 8bits	B4	10110100	180	
3A	HorzAct:HorzBlnk Upper 4:4 bits	70	01110000	112	
3B	Vertical Active Lower 8bits	38	00111000	56	
3C	Vertical Blanking Lower 8bits	26	00100110	38	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	40	01000000	64	
3E	HorzSync. Offset	30	00110000	48	
3F	HorzSync.Width	64	01100100	100	
40	VertSync.Offset : VertSync.Width	31	00110001	49	
41	Horz&Vert Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	35	00110101	53	
43	Vertical Image Size Lower 8bits	AD	10101101	173	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border <i>(zero for internal LCD)</i>	00	00000000	0	
46	Vertical Border <i>(zero for internal LCD)</i>	00	00000000	0	
47	Signal <i>(non-intr, norm, no stero, sep sync, neg pol)</i>	18	00011000	24	
48	Pixel Clock/10,000 (LSB)	B8	10111000	184	40Hz frame rate
49	Pixel Clock/10,000 (MSB)	24	00100100	36	
4A	Horizontal Addressable Pixels, lower 8 bits	80	10000000	128	
4B	Horizontal Blanking Pixels, lower 8 bits	B4	10110100	180	
4C	H Pixels, upper nibble : H Blanking, upper nibble	70	01110000	112	
4D	Vertical Addressable Lines, lower 8 bits	38	00111000	56	
4E	Vertical Blanking Lines, lower 8 bits	26	00100110	38	
4F	V lines, upper nibble : V blanking, upper nibble	40	01000000	64	
50	Horizontal Front Porch, lower 8 bits	30	00110000	48	
51	Horizontal Sync Pulse, lower 8 bits	64	01100100	100	
52	V Front Porch, lower nibble : V Sync Pulse, lower nibble	31	00110001	49	
53	VFP, 2 bits: VSP 2 bits: HFP 2 bits: HFP 2 bits	00	00000000	0	
54	Horizontal Image Size in mm, lower 8 bits	35	00110101	53	
55	Vertical Image Size in mm, lower 8 bits	AD	10101101	173	
56	H Image Size, upper nibble : V Image Size, upper nibble	10	00010000	16	
57	Horizontal Border	00	00000000	0	
58	Vertical Border	00	00000000	0	



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59	Bit Encode Sync Information	18	00011000	24	
5A	DC	00	00000000	0	nVDPS Reserved 00
5B	HTOTAL	00	00000000	0	
5C	HA	00	00000000	0	
5D	HBL	00	00000000	0	
5E	HFP	00	00000000	0	
5F	HFPe	00	00000000	0	
60	HBP	00	00000000	0	
61	HB	00	00000000	0	
62	HSO	00	00000000	0	
63	HS	00	00000000	0	
64	VTOTAL	00	00000000	0	
65	VA	00	00000000	0	
66	VBL	00	00000000	0	
67	VFP	00	00000000	0	
68	VBP	00	00000000	0	
69	VB	00	00000000	0	
6A	VSO	00	00000000	0	Header
6B	VS	00	00000000	0	
6C	Detail Timing Description #4	00	00000000	0	
6D	Flag	00	00000000	0	
6E	Reserved	00	00000000	0	
6F	For Brightness Table and Power Consumption	02	00000010	2	
70	Flag	00	00000000	0	Brightness Table
71	PWM % [7:0] @ Step 0	0C	00001100	12	
72	PWM % [7:0] @ Step 5	21	00100001	33	
73	PWM % [7:0] @ Step 10	FF	11111111	255	
74	Nits [7:0] @ Step 0	16	00010110	22	
75	Nits [7:0] @ Step 5	3C	00111100	60	
76	Nits [7:0] @ Step 10	D0	11010000	208	Power Consumption
77	Panel Electronics Power @ 32x32 Chess Pattern =	11	00010001	17	
78	Backlight Power @ 60 nits =	0B	00001011	11	
79	Backlight Power @ Step 10 =	24	00100100	36	
7A	Nits @ 100% PWM Duty =	D0	11010000	208	
7B	Flag	20	00100000	32	
7C	Flag	20	00100000	32	
7D	Flag	20	00100000	32	
7E	Extension Flag	00	00000000	0	
7F	Checksum	53	01010011	83	